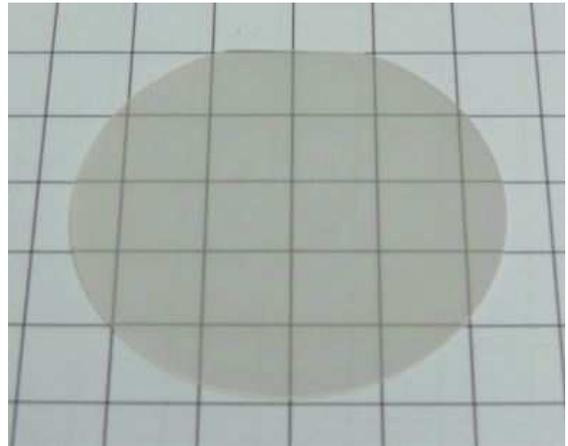


Customised epitaxy GaN structures on sapphire suitable for HEMTs, HB LEDs, photovoltaic cells

n-type GaN:Si on sapphire

- Up to 8 μ m GaN epitaxial layer on sapphire;
- Electron concentration up to $5 \cdot 10^{18}/\text{cm}^3$;
- Average electron mobility $\geq 300\text{cm}^2/\text{Vs}$;
- We can use either a conductive n-type or insulating GaN buffer between the n-type GaN and the substrate;
- We can manufacture an n-type GaN layer with electron concentration of $1.5 \cdot 10^{19}/\text{cm}^3$ if the layer thickness is $\leq 0.2\mu\text{m}$. In that case average electron mobility $\geq 150\text{cm}^2/\text{Vs}$.



3 μ m GaN n-type on 330 μ m 2" sapphire wafer.

p-type GaN:Mg on sapphire

- Up to 1.5 μ m GaN layer on sapphire;
- Hole concentration of up to $5 \cdot 10^{17}/\text{cm}^3$;
- We can use either a conductive (n-type) or insulating (C-compensated) GaN buffer between the p-type GaN and sapphire. We can also include a 10nm subcontact p-type layer Mg-concentration of up to $1.2 \cdot 10^{20}/\text{cm}^3$;
- Average hole mobility $\geq 10\text{cm}^2/\text{Vs}$;
- The client is encouraged to specify if the wafer should be activated or not.

semi-insulating GaN on sapphire

- We use carbon compensation. Typical resistivity larger than 1.5 M Ω cm;
- An example of a typical HEMT structure on semi-insulating GaN:
High resistivity C compensated GaN on Sapphire 2 μ m thick, undoped high mobility GaN channel (2DEG) 0.1 μ m thick, 1-1.5nm AlN spacer, 20nm thick Al_xGa_{1-x}N spacer, X=23%Al, 2-3nm Si₃N₄ cap.

All epi-wafers:

- Dislocation density EPD $\leq 5 \cdot 10^8/\text{cm}^2$; Thickness uniformity $< 10\%$ ($< 5\%$ on demand);
- XRD r.c. 002 FWHM $\leq 0.1^\circ \pm 10\%$ for structures $\geq 3\mu\text{m}$ thick;
- TTV $< 10\mu\text{m}$, bow $< 10\mu\text{m}$, warp $< 10\mu\text{m}$ (2" wafers), TTV $< 20\mu\text{m}$, bow $< 20\mu\text{m}$, warp $< 20\mu\text{m}$ (4" wafers).

Sapphire substrate specifications:

- We use 2", 3", 4" sapphire wafers;
- Thickness 330 μm , 430 μm , 550 μm , 650 μm or chosen by customers.

We also offer:

- InGaN – multi-quantum wells for LEDs and other epi structures demanded by customers;
- a-plane GaN deposited on r-plane sapphire (xrd 002 r.c. $\sim 0.35^\circ$);
- customized LED structures, wavelength of 390-450nm or higher on special request.

Single and double side polished wafers are available.